

Complementary Silicon Power Plastic Transistors

... designed for low power audio amplifier and low-current, high-speed switching applications.

• High Collector–Emitter Sustaining Voltage —

V_{CEO(sus)} = 100 Vdc (Min) — MJE243, MJE253

• High DC Current Gain @ I_C = 200 mAdc

h_{FE} = 40–200 = 40–120 — MJE243, MJE253

• Low Collector–Emitter Saturation Voltage —

 $V_{CE(sat)} = 0.3 \text{ Vdc (Max)} @ I_C = 500 \text{ mAdc}$

• High Current Gain Bandwidth Product —

 $f_T = 40 \text{ MHz (Min)} @ I_C = 100 \text{ mAdc}$

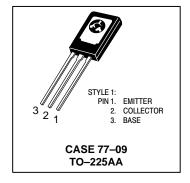
• Annular Construction for Low Leakages

ICBO = 100 nAdc (Max) @ Rated VCB

MJE243* PNP MJE253*

*ON Semiconductor Preferred Device

4 AMPERE
POWER TRANSISTORS
COMPLEMENTARY
SILICON
100 VOLTS
15 WATTS



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|-----------------------------------|--------------|---------------|
| Collector–Emitter Voltage | VCEO | 100 | Vdc |
| Collector–Base Voltage | V _{CB} | 100 | Vdc |
| Emitter–Base Voltage | V _{EB} | 7.0 | Vdc |
| Collector Current — Continuous Peak | IC | 4.0 8.0 | Adc |
| Base Current | ΙΒ | 10 | Adc |
| Total Power Dissipation @ T _C = 25°C Derate above 25°C | PD | 15 0.12 | Watts W/ac |
| Total Power Dissipation @ T _A = 25°C Derate @ 25°C | P _D | 1.5 0.012 | Watts W/°C |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | -65 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|--------|------|------|
| Thermal Resistance, Junction to Case | θJC | 8.34 | °C/W |
| Thermal Resistance, Junction to Ambient | θЈА | 83.4 | °C/W |

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

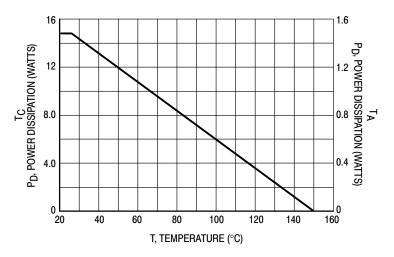
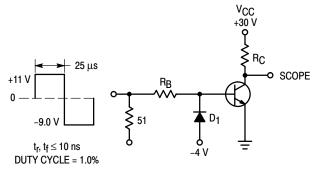


Figure 1. Power Derating

ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|--|------------------|----------|------------|------|
| DFF CHARACTERISTICS | | | | |
| Collector–Emitter Sustaining Voltage (I _C = 10 mAdc, I _B = 0) | VCEO(sus) | 100 | _ | Vdc |
| Collector Cutoff Current (V _{CB} = 100 Vdc, I _E = 0) (V _{CE} = 100 Vdc, I _E = 0, T _C = 125°C) | I _{CBO} | | 0.1 0.1 | μAdc |
| Emitter Cutoff Current (V _{BE} = 7.0 Vdc, I _C = 0) | I _{EBO} | | 0.1 | μAdc |
| ON CHARACTERISTICS | · | | • | • |
| DC Current Gain ($I_C = 200 \text{ mAdc}$, $V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 1.0 \text{ Adc}$, $V_{CE} = 1.0 \text{ Vdc}$) | hFE | 40 15 | 180 — | _ |
| Collector–Emitter Saturation Voltage (I _C = 500 mAdc, I _B = 50 mAdc) (I _C = 1.0 Adc, I _B = 100 mAdc) | VCE(sat) | _ | 0.3 0.6 | Vdc |
| Base–Emitter Saturation Voltage (I _C = 2.0 Adc, I _B = 200 mAdc) | VBE(sat) | _ | 1.8 | Vdc |
| Base–Emitter On Voltage (I _C = 500 mAdc, V _{CE} = 1.0 Vdc) | VBE(on) | _ | 1.5 | Vdc |
| DYNAMIC CHARACTERISTICS | | | | |
| Current–Gain — Bandwidth Product (I _C = 100 mAdc, V _{CE} = 10 Vdc, f _{test} = 10 MHz) | fT | 40 | _ | MHz |
| Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz) | C _{ob} | _ | 50 | pF |



 R_B and R_C Varied to obtain desired current levels D $_1$ MUST be fast recovery type, e.g.: 1N5825 USED ABOVE I $_B\approx 100$ mA MSD6100 USED BELOW I $_B\approx 100$ mA FOR PNP TEST CIRCUIT, REVERSE ALL POLARITIES

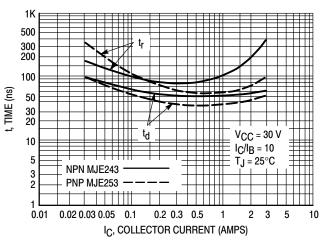


Figure 3. Turn-On Time

Figure 2. Switching Time Test Circuit

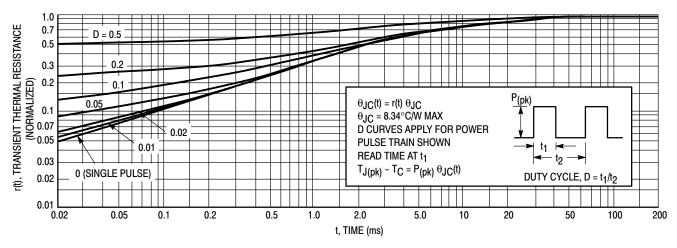


Figure 4. Thermal Response

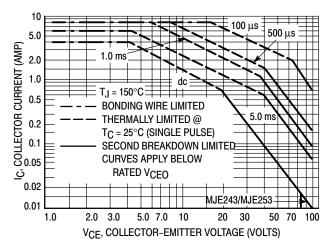
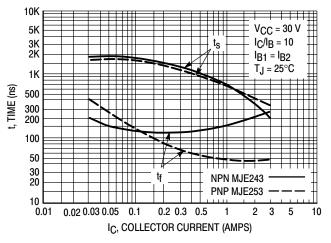
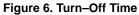


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ}C$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.





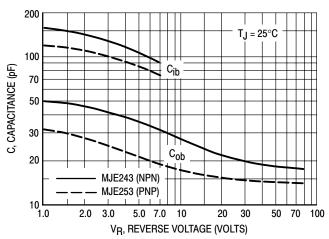


Figure 7. Capacitance

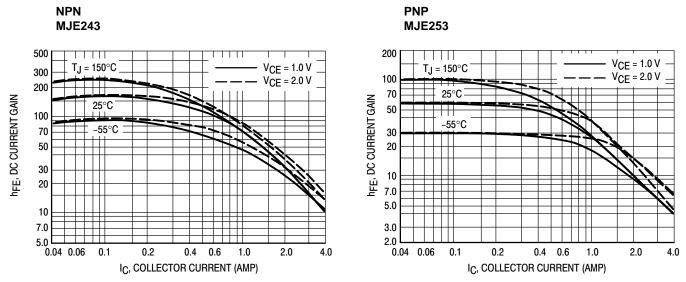


Figure 8. DC Current Gain

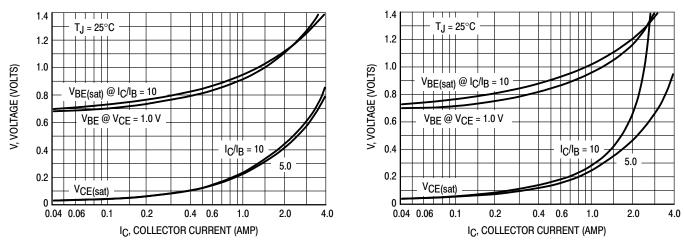


Figure 9. "On" Voltages

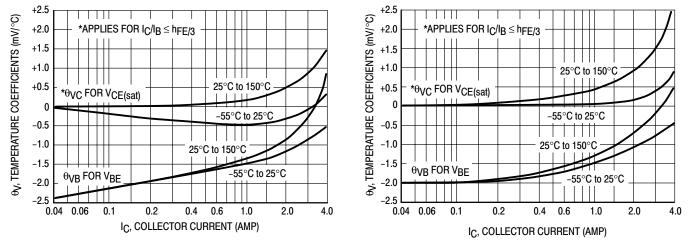
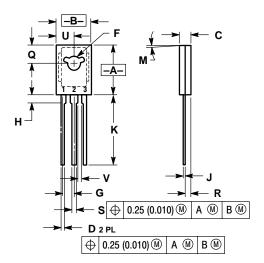


Figure 10. Temperature Coefficients

PACKAGE DIMENSIONS

TO-225AA **CASE 77-09 ISSUE W**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

| | INCHES | | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.425 | 0.435 | 10.80 | 11.04 | |
| В | 0.295 | 0.305 | 7.50 | 7.74 | |
| С | 0.095 | 0.105 | 2.42 | 2.66 | |
| D | 0.020 | 0.026 | 0.51 | 0.66 | |
| F | 0.115 | 0.130 | 2.93 | 3.30 | |
| G | 0.094 BSC | | 2.39 BSC | | |
| Н | 0.050 | 0.095 | 1.27 | 2.41 | |
| J | 0.015 | 0.025 | 0.39 | 0.63 | |
| K | 0.575 | 0.655 | 14.61 | 16.63 | |
| M | 5° TYP | | 5° TYP | | |
| Q | 0.148 | 0.158 | 3.76 | 4.01 | |
| R | 0.045 | 0.065 | 1.15 | 1.65 | |
| S | 0.025 | 0.035 | 0.64 | 0.88 | |
| U | 0.145 | 0.155 | 3.69 | 3.93 | |
| ٧ | 0.040 | | 1.02 | | |

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. BASE



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